Special Issue

Biometric Identification Systems: Recent Advances and Future Directions

Message from the Guest Editors

In this Special Issue, we seek research and case studies that show the recent advances of the biometric identification systems as well as the future directions of this field. Example topics include, but are not limited to, the following:

- Security, privacy and challenges in biometric systems;
- Smart government solutions related to biometric systems;
- Emergent biometrics techniques;
- Challenges and opportunities related to biometric systems;
- Trends linking biometrics with business applications;
- Innovations and best practices related to biometric applications;
- Biometrics in health systems;
- Artificial Intelligence in biometrics;
- Biometrics based on blockchain;
- Biometrics on mobiles devices:
- Future of biometrics in relation with policy development:
- Cloud-based biometric applications;
- Biometric coprocessors and accelerators:
- Biometrics and post-quantum systems.

Guest Editors

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Deadline for manuscript submissions

closed (25 May 2022)



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About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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